

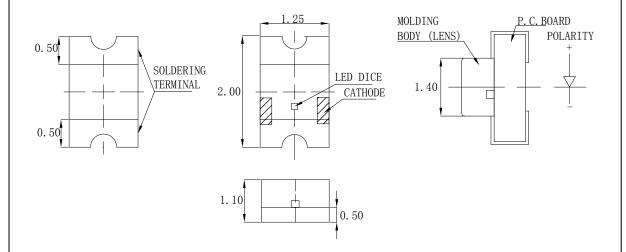
Features

- 2.0mm*1.25mm SMT LED, Super thin (1.10H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Products
- Package: 3000pcs/Reel

Applications

• Backlight and Indicator

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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FSL-20125110G-FATNKBJCX

Se	Selection Guide					
	Part No	Lens Type	Dice	Emitted Color		
	FSL-20125110G-FATNKBJCX	Water Clear	InGaAlP	Green		

Electrical / Optical Characteristics At Ta=25°C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condition
Iv	Iv Luminous Intensity		12.5		mcd	IF=20mA
201/2	Viewing Angle		120		deg	IF=20mA
入 Peak	Peak Emission Wavelength		574		nm	IF=20mA
入 d	Dominant Wavelength		570		nm	IF=20mA
$\triangle \lambda$	Spectral Line Half-Width		20		nm	IF=20mA
С	Capacitance		15		рF	V _F =0V,f=1MHz
VF	Forward Voltage	1.7	2.1	2.5	V	IF=20mA
IR	Reverse Current			10	μА	VR 5V

Note:

 $1.\,\theta1/2$ is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value

Absolute Maximum Ratings At Ta=25℃

Parameter	Green	Unit		
Power Dissipation	75	mW		
Peak Forward Current[1]	150	mA		
Continuous Forward Current	30	mA		
Dreading Linear From25 ℃	0.4	mA/°C		
Reverse Voltage	5	V		
Electrostatic Discharge Threshold(HBM)	2000	V		
Operating Temperature Range	-40°C to + 85°C			
Storage Temperature Range	-40°C to + 85°C			
Soldering Condition	260℃ For 5 Seconds			

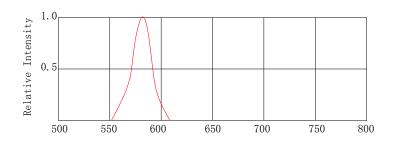
Note

 $1.\ 1/10 Duty Cycle, \ 0.1 ms Pulse Width$

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Electrical Optical Characteristics Curves At Ta=25 °C



 $\label{eq:wavelength} \begin{tabular}{ll} Wavelength & λ (nm) \\ Fig. 1 Relative Intensity vs. Wavelength \\ \end{tabular}$

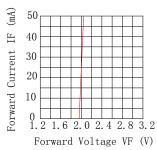


Fig. 2 Forward Current VS. Forward Voltage

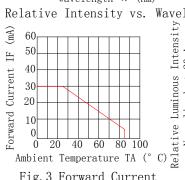
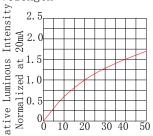
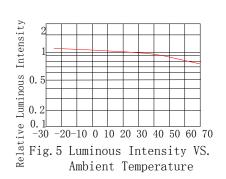


Fig. 3 Forward Current Derating Curve



Forward Current (mA)
Fig. 4 Relative Luminous
Intensity VS. Forward
Current



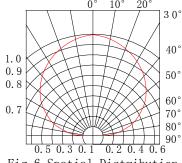
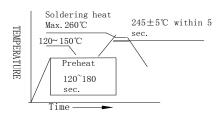


Fig. 6 Spatial Distribution

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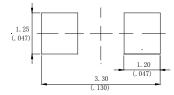
SMT Reflow Soldering Instructions



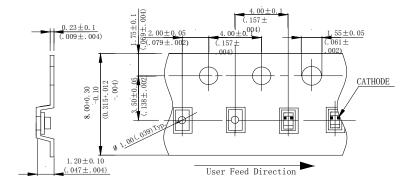
Notes:

- Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm (inches))



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5\sim30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

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Reliability Test Items Conditions

Classification	Test Item	Test Conditions	Test hours	Result
	Operation Life	Connect with a power IF=20mA Ta=Under room temperature	1000Hrs	0/20
F 1	High Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	High Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C ~±5°C ~+85°C ~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	IF=20mA	Over U×1.2
Reverse current	Ir(µA)	V _R =5V	Over U×2
Luminous intensity	Iv(mcd)	IF=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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